



N-Ch and P-Ch Fast Switching MOSFETs

Description

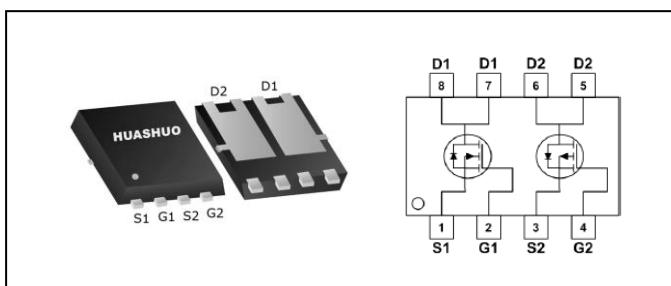
The HSBA6901 is the high performance complementary N-ch and P-ch MOSFETs with high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The HSBA6901 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Product Summary

| BVDSS | RDSON | ID |
|-------|-------|------|
| 60V | 32mΩ | 23A |
| -60V | 70mΩ | -18A |

PRPAK5*6 Pin Configuration



Absolute Maximum Ratings

| Symbol | Parameter | Rating | | Units |
|---------------------------------------|--|------------|------------|-------|
| | | N-Channel | P-Channel | |
| V _{DS} | Drain-Source Voltage | 60 | -60 | V |
| V _{GS} | Gate-Source Voltage | ±20 | ±20 | V |
| I _D @T _c =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 23 | -18 | A |
| I _D @T _c =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 15 | -11 | A |
| I _D @T _A =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 5.6 | -4.3 | A |
| I _D @T _A =70°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 4.5 | -3.5 | A |
| I _{DM} | Pulsed Drain Current ² | 46 | -36 | A |
| EAS | Single Pulse Avalanche Energy ³ | 26.5 | 39.2 | mJ |
| I _{AS} | Avalanche Current | 23 | -28 | A |
| P _D @T _c =25°C | Total Power Dissipation ⁴ | 42 | 42 | W |
| T _{STG} | Storage Temperature Range | -55 to 150 | -55 to 150 | °C |
| T _J | Operating Junction Temperature Range | -55 to 150 | -55 to 150 | °C |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|------------------|--|------|------|------|
| R _{θJA} | Thermal Resistance Junction-Ambient ¹ | --- | 62 | °C/W |
| R _{θJC} | Thermal Resistance Junction-Case ¹ | --- | 3 | °C/W |

N-Ch and P-Ch Fast Switching MOSFETs
N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--|--|---|------|-------|-----------|----------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$ | 60 | --- | --- | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_{\text{D}}=1\text{mA}$ | --- | 0.063 | --- | $\text{V}/^\circ\text{C}$ |
| $R_{\text{DS}(\text{ON})}$ | Static Drain-Source On-Resistance ² | $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=15\text{A}$ | --- | --- | 32 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=10\text{A}$ | --- | --- | 38 | |
| $V_{\text{GS}(\text{th})}$ | Gate Threshold Voltage | $V_{\text{GS}}=V_{\text{DS}}$, $I_{\text{D}}=250\mu\text{A}$ | 1.2 | --- | 2.5 | V |
| $\Delta V_{\text{GS}(\text{th})}$ | $V_{\text{GS}(\text{th})}$ Temperature Coefficient | | --- | -5.24 | --- | $\text{mV}/^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}}=48\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | uA |
| | | $V_{\text{DS}}=48\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=55^\circ\text{C}$ | --- | --- | 5 | |
| I_{GSS} | Gate-Source Leakage Current | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | --- | --- | ± 100 | nA |
| g_{fs} | Forward Transconductance | $V_{\text{DS}}=5\text{V}$, $I_{\text{D}}=15\text{A}$ | --- | 17 | --- | S |
| R_g | Gate Resistance | $V_{\text{DS}}=0\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 3.2 | --- | Ω |
| Q_g | Total Gate Charge (4.5V) | $V_{\text{DS}}=48\text{V}$, $V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=12\text{A}$ | --- | 12.56 | --- | nC |
| Q_{gs} | Gate-Source Charge | | --- | 3.24 | --- | |
| Q_{gd} | Gate-Drain Charge | | --- | 6.31 | --- | |
| $T_{\text{d}(\text{on})}$ | Turn-On Delay Time | $V_{\text{DD}}=30\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_g=3.3\Omega$, $I_{\text{D}}=10\text{A}$ | --- | 8 | --- | ns |
| T_r | Rise Time | | --- | 14.2 | --- | |
| $T_{\text{d}(\text{off})}$ | Turn-Off Delay Time | | --- | 24.4 | --- | |
| T_f | Fall Time | | --- | 4.6 | --- | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 1378 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 86 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 64 | --- | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|--|--|------|------|------|------|
| I_s | Continuous Source Current ^{1,5} | $V_G=V_D=0\text{V}$, Force Current | --- | --- | 23 | A |
| I_{SM} | Pulsed Source Current ^{2,5} | | --- | --- | 46 | A |
| V_{SD} | Diode Forward Voltage ² | $V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | 1.2 | V |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}=25\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=23\text{A}$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



N-Ch and P-Ch Fast Switching MOSFETs

P-Channel Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--|--|--|------|-------|-----------|------------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_{\text{D}}=-250\mu\text{A}$ | -60 | --- | --- | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $\text{I}_{\text{D}}=-1\text{mA}$ | --- | -0.03 | --- | $\text{V}/^{\circ}\text{C}$ |
| $\text{R}_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance ² | $\text{V}_{\text{GS}}=-10\text{V}$, $\text{I}_{\text{D}}=-12\text{A}$ | --- | --- | 70 | $\text{m}\Omega$ |
| | | $\text{V}_{\text{GS}}=-4.5\text{V}$, $\text{I}_{\text{D}}=-8\text{A}$ | --- | --- | 105 | |
| $\text{V}_{\text{GS(th)}}$ | Gate Threshold Voltage | $\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$, $\text{I}_{\text{D}}=-250\mu\text{A}$ | -1.2 | --- | -2.5 | V |
| $\Delta \text{V}_{\text{GS(th)}}$ | $\text{V}_{\text{GS(th)}}$ Temperature Coefficient | | --- | 4.56 | --- | $\text{mV}/^{\circ}\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $\text{V}_{\text{DS}}=-48\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=25^{\circ}\text{C}$ | --- | --- | 1 | uA |
| | | $\text{V}_{\text{DS}}=-48\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $T_J=55^{\circ}\text{C}$ | --- | --- | 5 | |
| I_{GSS} | Gate-Source Leakage Current | $\text{V}_{\text{GS}}=\pm 20\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$ | --- | --- | ± 100 | nA |
| g_{fs} | Forward Transconductance | $\text{V}_{\text{DS}}=-5\text{V}$, $\text{I}_{\text{D}}=-12\text{A}$ | --- | 15 | --- | S |
| R_g | Gate Resistance | $\text{V}_{\text{DS}}=0\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 13.5 | --- | Ω |
| Q_g | Total Gate Charge (-4.5V) | $\text{V}_{\text{DS}}=-48\text{V}$, $\text{V}_{\text{GS}}=-4.5\text{V}$, $\text{I}_{\text{D}}=-12\text{A}$ | --- | 9.86 | --- | nC |
| Q_{gs} | Gate-Source Charge | | --- | 3.08 | --- | |
| Q_{gd} | Gate-Drain Charge | | --- | 2.95 | --- | |
| $\text{T}_{\text{d(on)}}$ | Turn-On Delay Time | $\text{V}_{\text{DD}}=-15\text{V}$, $\text{V}_{\text{GS}}=-10\text{V}$, $\text{R}_g=3.3\Omega$, $\text{I}_{\text{D}}=1\text{A}$ | --- | 28.8 | --- | ns |
| T_r | Rise Time | | --- | 19.8 | --- | |
| $\text{T}_{\text{d(off)}}$ | Turn-Off Delay Time | | --- | 60.8 | --- | |
| T_f | Fall Time | | --- | 7.2 | --- | |
| C_{iss} | Input Capacitance | $\text{V}_{\text{DS}}=-15\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 1447 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 97 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 70 | --- | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------------------|--|--|------|------|------|------|
| I_s | Continuous Source Current ^{1,5} | $\text{V}_G=\text{V}_D=0\text{V}$, Force Current | --- | --- | -18 | A |
| I_{SM} | | | --- | --- | -36 | A |
| V_{SD} | Diode Forward Voltage ² | $\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_{\text{s}}=-1\text{A}$, $T_J=25^{\circ}\text{C}$ | --- | --- | -1.2 | V |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $\text{V}_{\text{DD}}=-25\text{V}$, $\text{V}_{\text{GS}}=-10\text{V}$, $L=0.1\text{mH}$, $\text{I}_{\text{AS}}=-28\text{A}$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



N-Channel Typical Characteristics

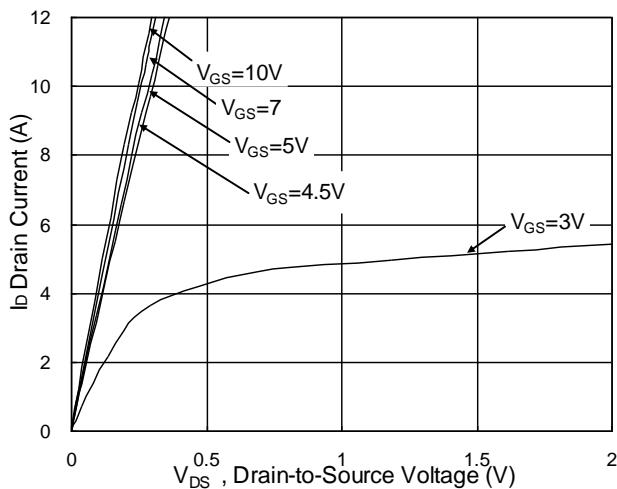


Fig.1 Typical Output Characteristics

N-Ch and P-Ch Fast Switching MOSFETs

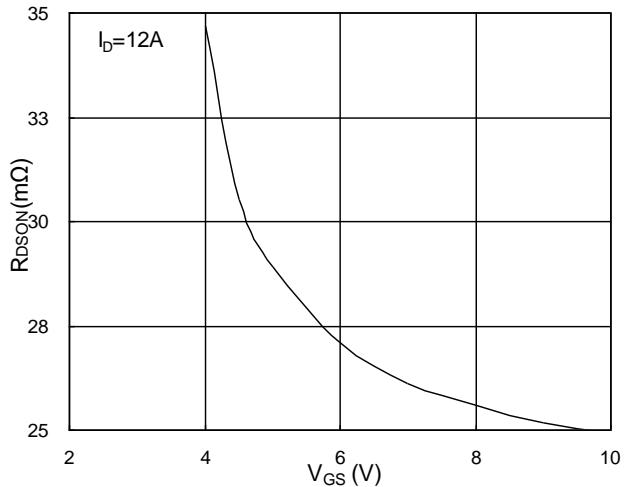


Fig.2 On-Resistance v.s Gate-Source

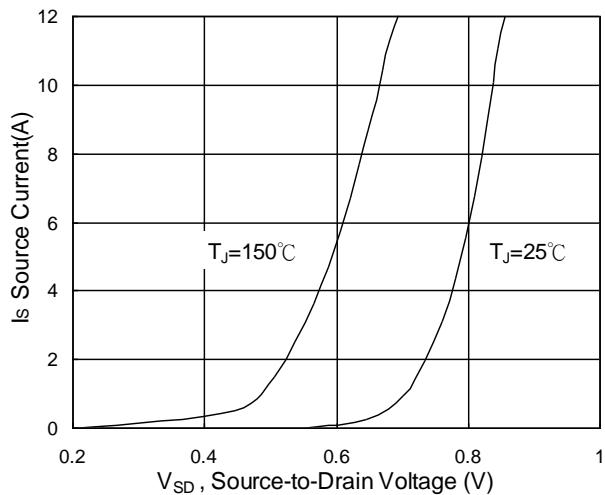


Fig.3 Forward Characteristics of Reverse

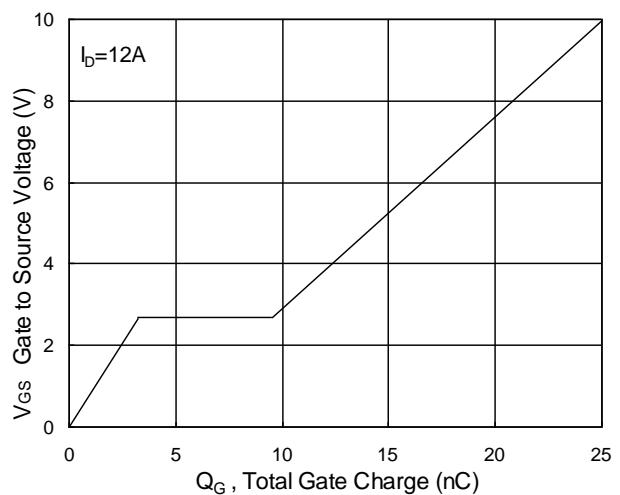


Fig.4 Gate-Charge Characteristics

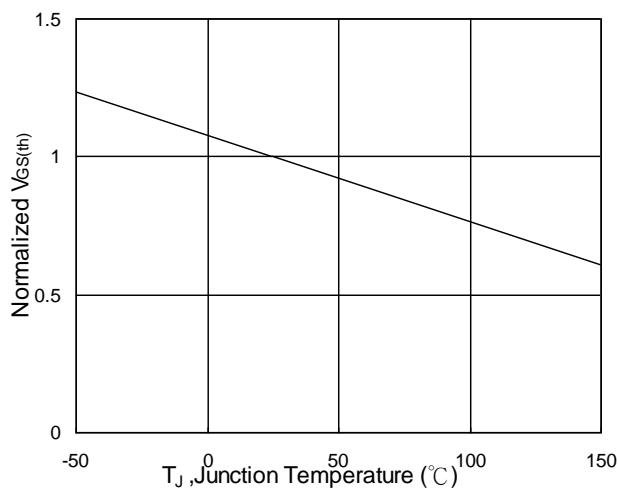


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

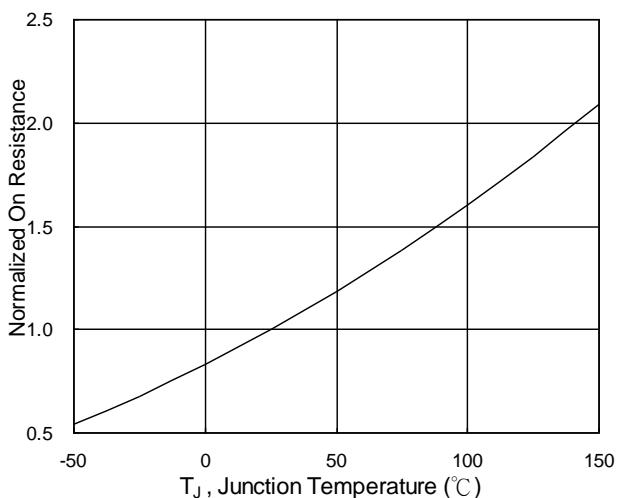


Fig.6 Normalized $R_{DS(on)}$ v.s T_J



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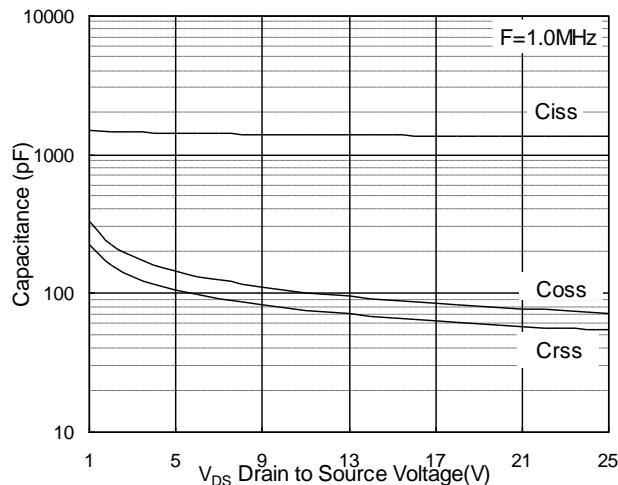


Fig.7 Capacitance

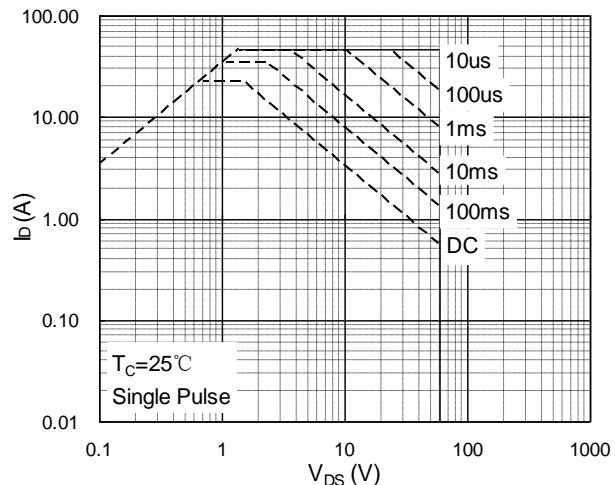


Fig.8 Safe Operating Area

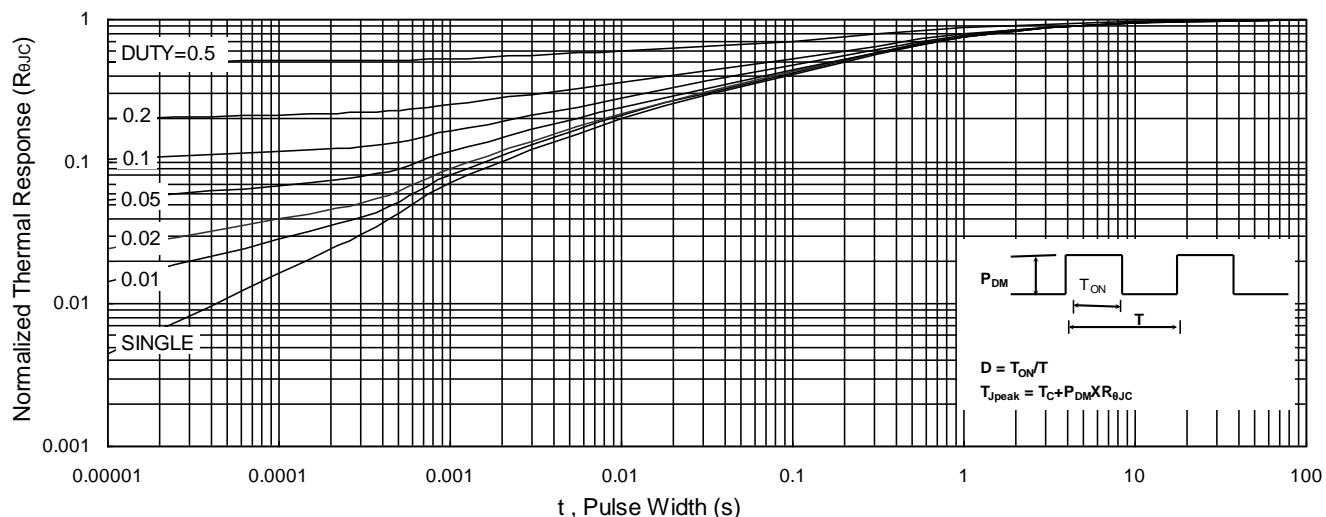


Fig.9 Normalized Maximum Transient Thermal Impedance

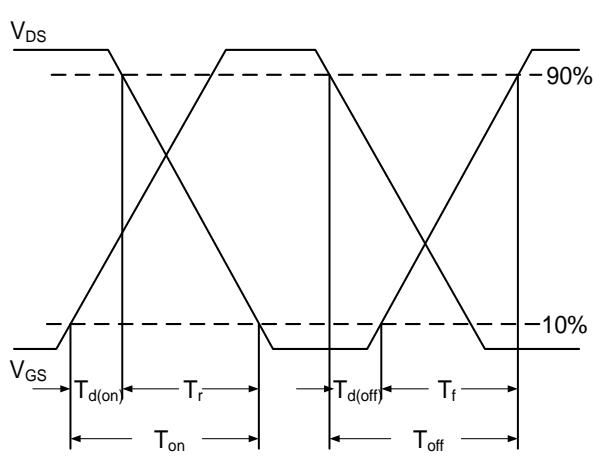


Fig.10 Switching Time Waveform

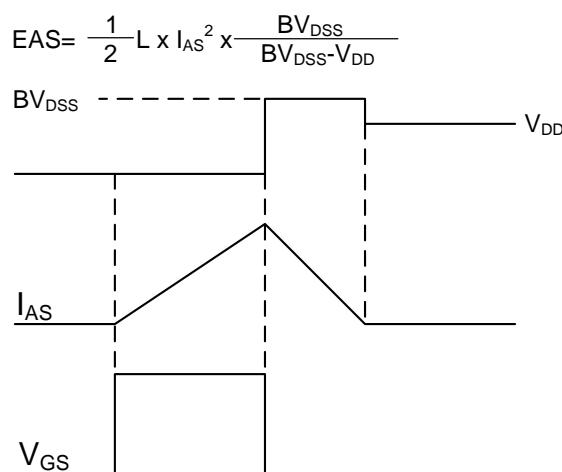


Fig.11 Unclamped Inductive Waveform



P-Channel Typical Characteristics

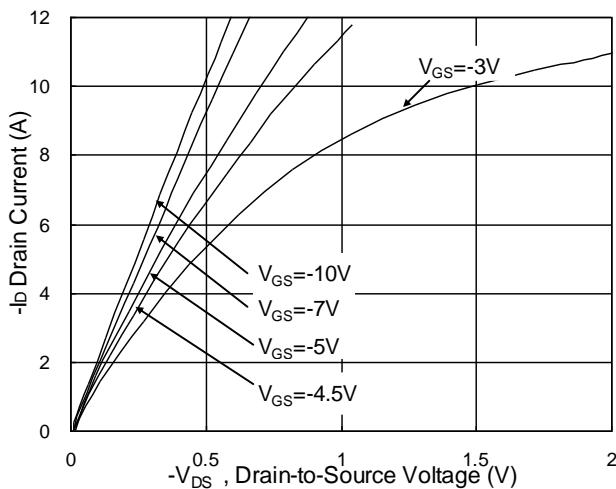


Fig.1 Typical Output Characteristics

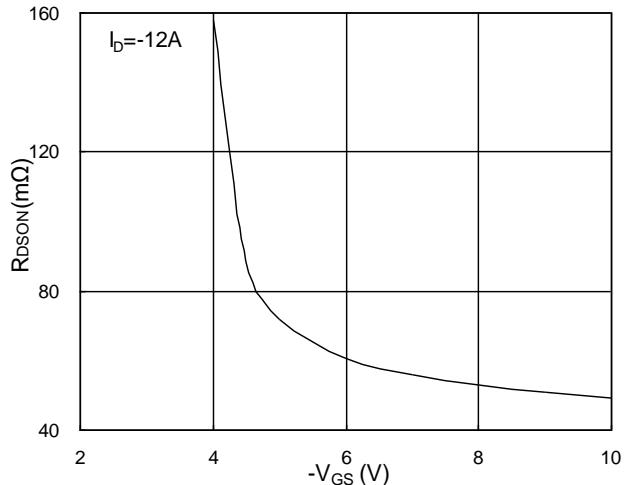


Fig.2 On-Resistance v.s Gate-Source

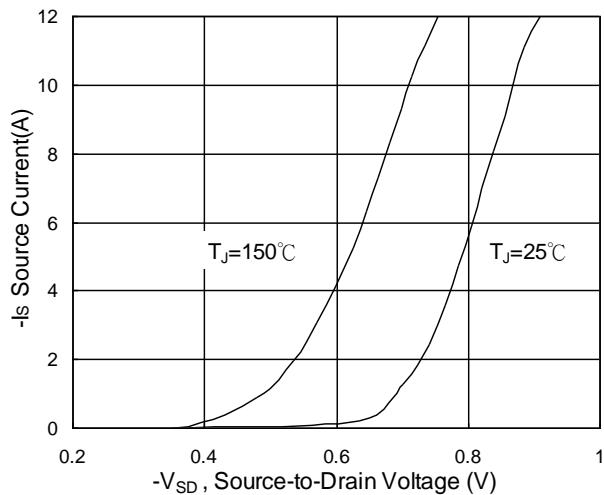


Fig.3 Forward Characteristics of Reverse

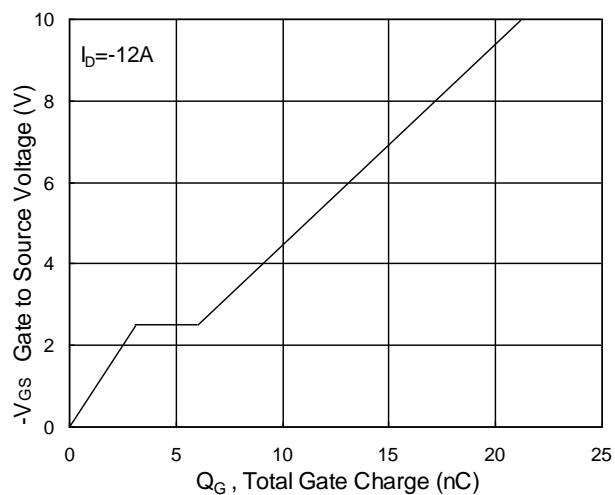


Fig.4 Gate-Charge Characteristics

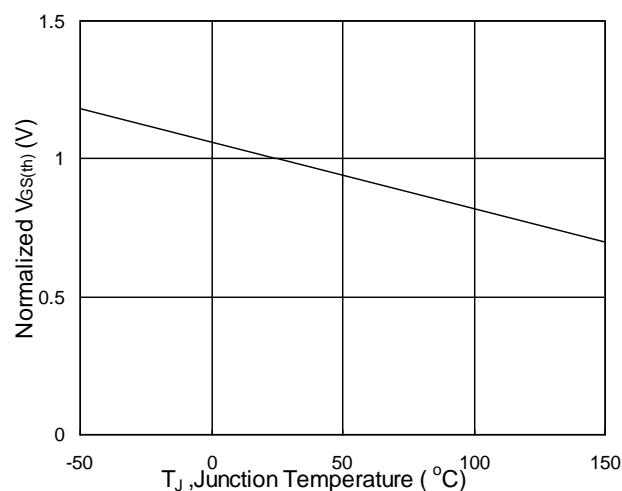


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

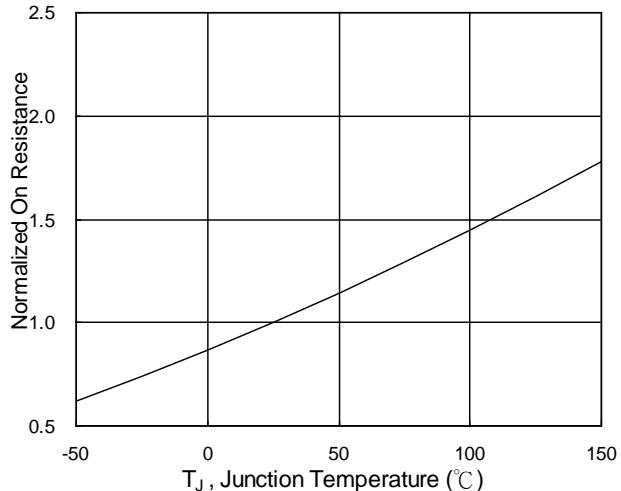


Fig.6 Normalized $R_{DS(on)}$ v.s T_J



N-Ch and P-Ch Fast Switching MOSFETs

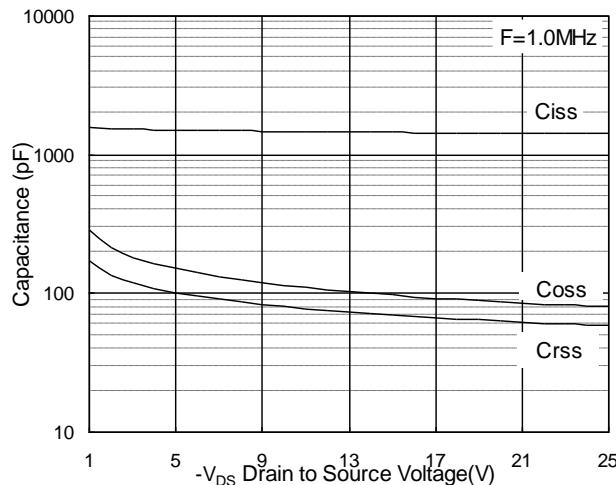


Fig.7 Capacitance

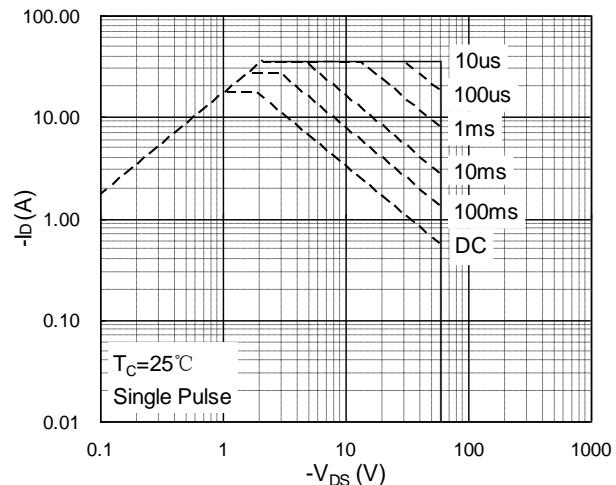


Fig.8 Safe Operating Area

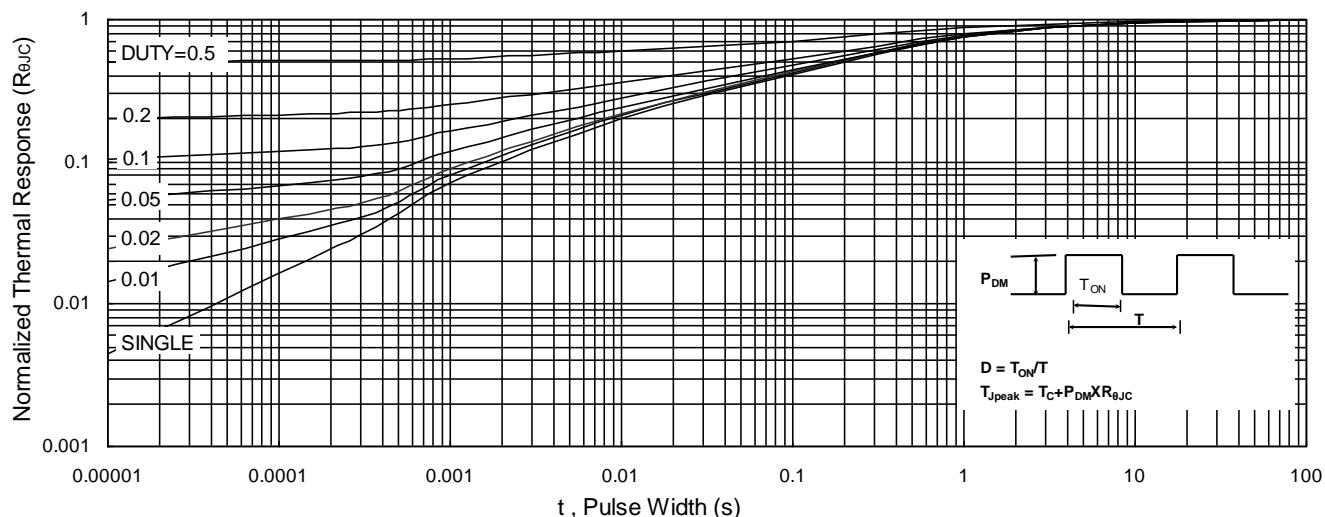


Fig.9 Normalized Maximum Transient Thermal Impedance

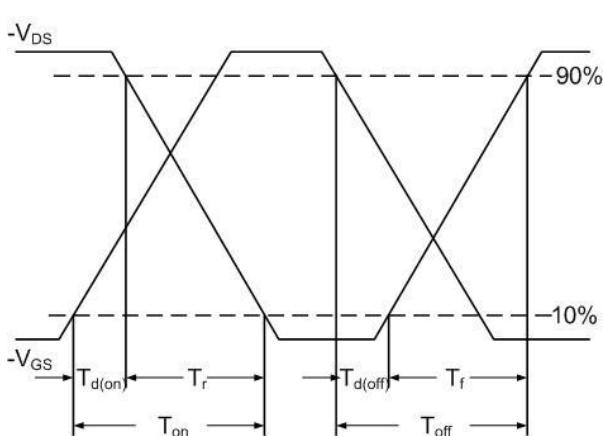


Fig.10 Switching Time Waveform

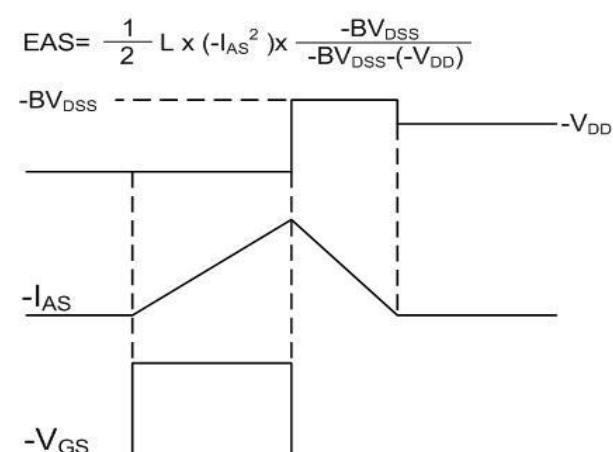


Fig.11 Unclamped Inductive Waveform